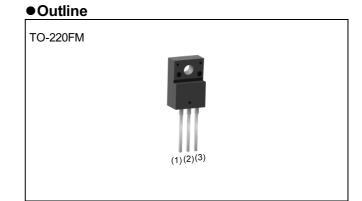


R6022YNX

Nch 600V 137mohm(typ)Power MOSFET

V _{DSS} (@Tj max.) ^{*5}	650V
R _{DS(on)} (Max.)	165mΩ
I _{DP} *2	±66A
P _D	65W



Inner circuit

(1) o (1) o (1) o (1) o (1) Gate (2) Drain (2) Drain (3) Source *1 Body Diode

Application

Features

1) Low on-resistance

3) Drive circuits can be simple

4) Pb-free plating ; RoHS compliant

5) Halogen free mold compound

2) Fast switching

Switching applications

Marking R6022YNX

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	600	V
Continuous drain current ($T_c = 25^{\circ}C$)	ا _D *1	±13	А
Pulsed drain current	۱ _{DP} *2	±66	А
Gate - Source voltage	V _{GSS}	±30	V
Avalanche current, single pulse	I _{AS}	1.9	A
Avalanche energy, single pulse	E _{AS} *3	93	mJ
MOSFET dv/dt	dv/dt*4	120	V/ns
Power dissipation $(T_c = 25^{\circ}C)$	P _D	65	W
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

•Thermal resistance

Deremeter	Cumph of	Values			Lincit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	1.92	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	62.5	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

• Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Currence of	Conditions	Values			Lipit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 600V, V _{GS} = 0V	-	-	100	μA
Gate - Source leakage current	I _{GSS}	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 1.8 \text{mA}$	4	5	6	V
Static drain - source	D *5	V _{GS} = 12V, I _D = 6.5A	-	137	165	mΩ
on - state resistance	${\sf R}_{\sf DS(on)}{}^{*5}$	V _{GS} = 10V, I _D = 6.5A	-	144	175	mΩ
Gate resistance	R _G	f = 1MHz, open drain	-	1.8	-	Ω



•Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumahal	Conditions	Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 100V	-	1400	-	
Output capacitance	C _{oss}	f = 100kHz	-	45	-	
Effective output capacitance energy related	C _{o(er)} *6	V _{GS} = 0V	-	45	-	pF
Effective output capacitance time related	C _{o(tr)} *7	$V_{DS} = 0V$ to 480V	-	300	-	
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300$ V, V_{GS} = 12V	-	27	-	
Rise time	t _r *5	I _D = 6.5A	-	21	-	
Turn - off delay time	$t_{d(off)}$ *5	$R_L \simeq 46\Omega$	-	54	-	ns
Fall time	t _f *5	R _G = 10Ω	-	18	-	

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Cumph of	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	$V_{DD} \simeq 300V$	-	33	-	
Gate - Source charge	Q _{gs} *5	I _D = 6.5A	-	11	-	nC
Gate - Drain charge	Q_{gd}^{*5}	V _{GS} = 10V	-	16	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300$ V, I _D = 6.5A	-	7.5	-	V



• Body diode electrical characteristics (Source-Drain) ($T_a = 25^{\circ}C$)

Deremeter	Cumpbel	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Source current	I_S^{*1}	• T _C = 25°C	-	-	13	А
Pulsed source current	I_{SP}^{*2}	1 _C - 25 C	-	-	66	А
Source-Drain voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 6.5A	-	-	1.5	V
Reverse recovery time	t _{rr} *5	• V _{DD} ≃ 400V	-	290	-	ns
Reverse recovery charge	Q _{rr} *5	I _S = 6.5A	-	3.6	-	μC
Peak reverse recovery current	۱ *5	di/dt = 100A/µs	-	25.5	-	А

*1 Limited only by maximum channel temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \doteqdot 50mH, V_{DD}=50V, R_G=25 Ω , starting T_j=25°C

*4 V_{DS} = 0 to 400V

*5 Pulsed

*6 Co(er) is a fixed capacitance that gives the same stored energy as Coss while V_{DS} is rising from 0 to 80% V_{DSS}.

*7 Co(tr) is a fixed capacitance that gives the same charging time as Coss while V_{DS} is rising from 0 to 80% V_{DSS}.



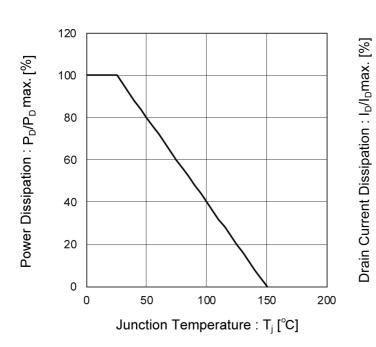


Fig.1 Power Dissipation Derating Curve

Fig.2 Drain Current Derating Curve vs. Junction Temperature

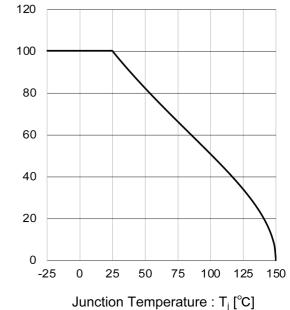
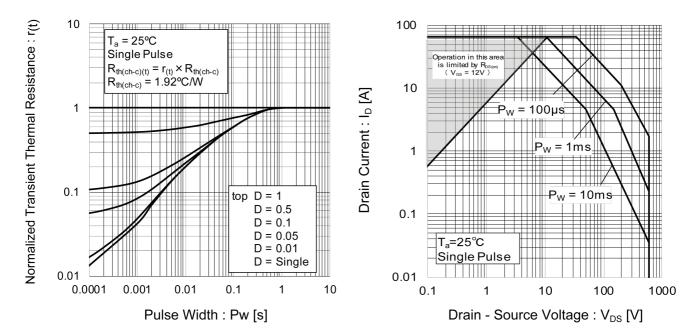


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Maximum Safe Operating Area

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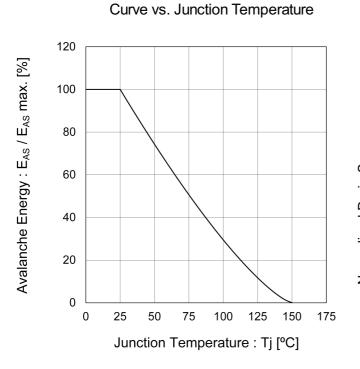


Fig.5 Avalanche Energy Derating

Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

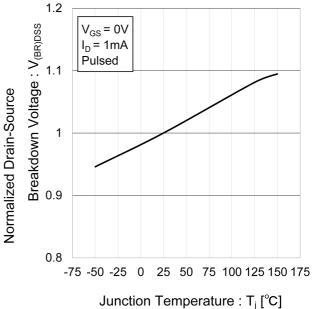
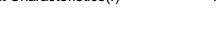
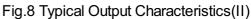
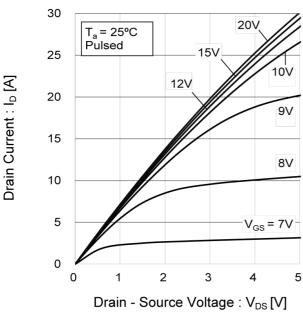
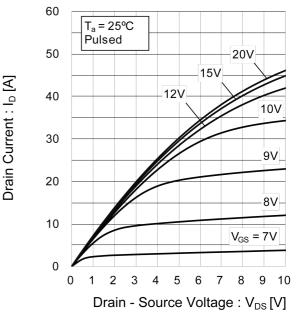


Fig.7 Typical Output Characteristics(I)









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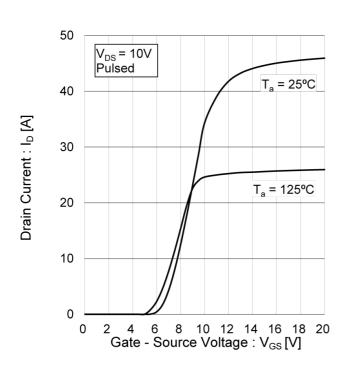


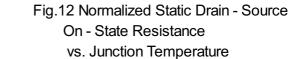
Fig.11 Static Drain - Source On - State

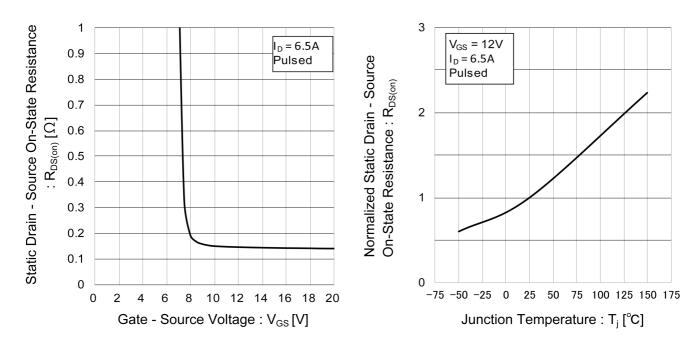
Resistance vs. Gate Source Voltage

Fig.9 Typical Transfer Characteristics

1.5 $V_{DS} = V_{GS}$ **Normalized Gate Threshold Voltage** 1.4 $I_{D} = 1.8 mA$ 1.3 Pulsed 1.2 1.1 $: V_{GS(th)}$ 1 0.9 0.8 0.7 0.6 0.5 -75 -50 -25 0 25 50 75 100 125 150 175 Junction Temperature : T_i [°C]

Fig.10 Normalized Gate Threshold Voltage vs. Junction Temperature





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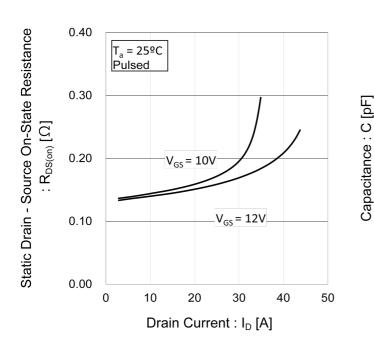
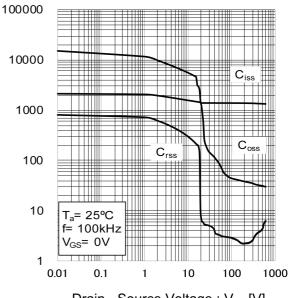


Fig.13 Static Drain - Source On - State

Resistance vs. Drain Current

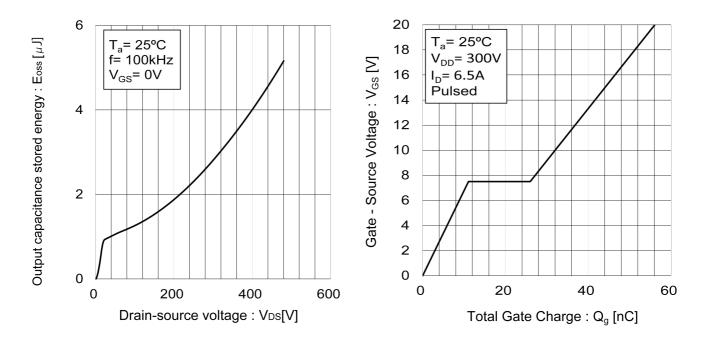
Fig.14 Capacitances



Drain - Source Voltage : V_{DS} [V]

Fig.15 Coss Stored Energy

Fig.16 Gate charge



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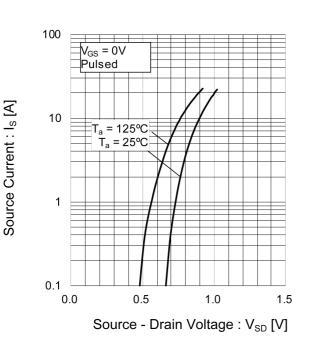
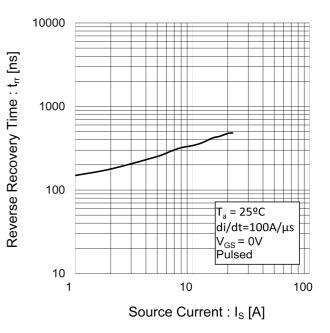


Fig.17 Source Current vs. Source - Drain Voltage

Fig.18 Reverse Recovery Time vs. Source Current





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Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

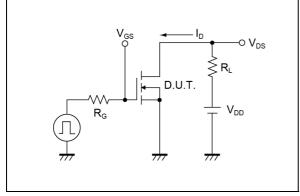


Fig.2-1 Gate Charge Measurement Circuit

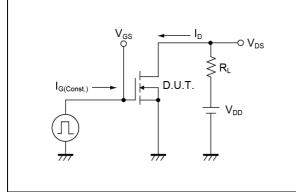


Fig.3-1 Avalanche Measurement Circuit

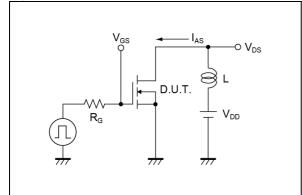


Fig.4-1 trr Measurement Circuit

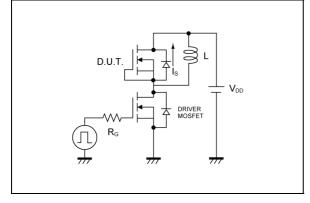


Fig.1-2 Switching Waveforms

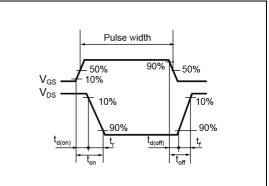


Fig.2-2 Gate Charge Waveform

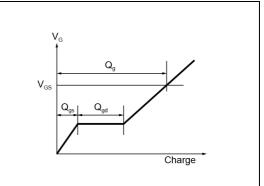


Fig.3-2 Avalanche Waveform

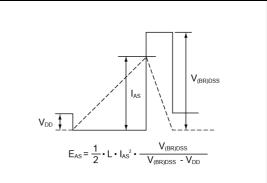
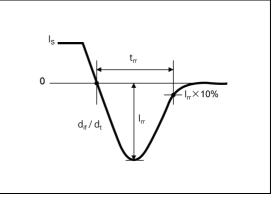
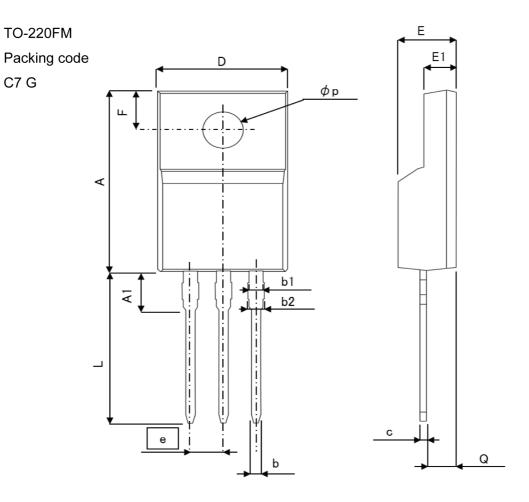


Fig.4-2 trr Waveform



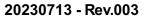


Dimensions



DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	15.67	16.27	0.617	0.641
A1	3.03	3.43	0.119	0.135
b	0.70	0.95	0.028	0.037
b1	1.00	1.40	0.039	0.055
b2	1.10	1.50	0.043	0.059
с	0.45	0.65	0.018	0.026
D	9.90	10.30	0.390	0.406
E	4.60	5.00	0.181	0.197
E1	2.44	2.74	0.096	0.108
е	2.	54	0.1	00
F	3.10	3.50	0.122	0.138
L	12.6	13.6	0.946	0.535
р	2.98	3.38	0.117	0.133
Q	2.25	3.25	0.089	0.128

Dimension in mm/inches



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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSI	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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